TOSHIBA TLN115A

TOSHIBA INFRARED LED GaAs INFRARED EMITTER

TLN115A

INFRARED LED FOR REMOTE CONTROL SYSTEM

REMOTE CONTROL SYSTEM

High radiant intensity : $I_E = 26mW / sr (TYP.)$

Wide half value angle : $\theta \frac{1}{2} = \pm 21^{\circ}$ (TYP.)

Excellent linearity of radiant intensity and modulation by pulse operation and high frequency is possible.

PIN photo diode TPS703 provided with a visible light cut filter is available for light receiving element for remote control.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current	${ m I_F}$	100	mA
Forward Current Derating (Ta>25°C)	$\Delta I_{\mathbf{F}}/^{\circ}\mathbf{C}$	-1.33	mA/°C
Pulse Forward Current (Note)	$I_{ extbf{FP}}$	1	A
Reverse Voltage	$ m v_R$	5	V
Power Dissipation	$P_{\mathbf{D}}$	150	mW
Operation Temperature Range	$\mathrm{T}_{\mathrm{opr}}$	-20~75	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-30~85	°C

Unit in mm 0.5 ± 0.1 (): REFERENCE VALUE **JEDEC EIAJ TOSHIBA** 4-6B6

Weight: 0.3g (TYP.)

PIN CONNECTION

 $1 \circ \longrightarrow 2$ 1. ANODE 2. CATHODE

(Note) Pulse Width $\leq 100 \,\mu s$, Repetitive Frequency = 100Hz

OPTO-ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage	$V_{\mathbf{F}}$	$I_{\mathbf{F}} = 100 \text{mA}$	_	1.35	1.5	V
Reverse Current	$I_{ m R}$	$V_R = 5V$	_	_	10	μ A
Radiant Intensity (Note)	${f I_E}$	$I_{\mathbf{F}} = 50 \text{mA}$	15	26	_	mW/sr
Radiant Power	PO	$I_{\mathbf{F}} = 50 \text{mA}$	_	13	_	mW
Capacitance	$ m C_{T}$	$V_R = 0$, $f = 1MHz$	_	20		рF
Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	$I_{\mathbf{F}} = 50 \text{mA}$	_	950	_	nm
Spectral Line Half Width	Δλ	$I_{\mathbf{F}} = 50 \text{mA}$	_	50	_	nm
Half Value Angle	$\theta_{\frac{1}{2}}$	$I_{\mathbf{F}} = 50 \text{mA}$	_	±21	_	0

(Note) IE classification B : 19mW/sr MIN.

961001EAC2

TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

TOSHIBA TLN115A

PRECAUTION

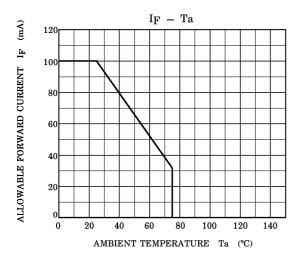
Please be careful of the followings.

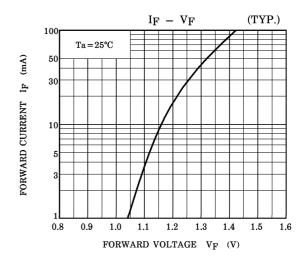
- Soldering shall be performed at the top portion from the lead stopper.
- Soldering temperature: 260°C MAX. Solderint time: 5 sec MAX.
- 3. When the lead is formed, the lead shall be formed at the top portion of the stopper without leaving forming stress to the body of the device. Soldering shall be performed after lead forming.

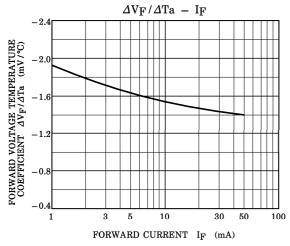
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Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

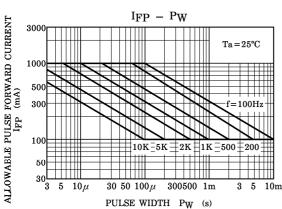
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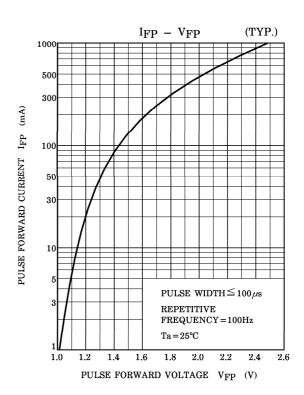








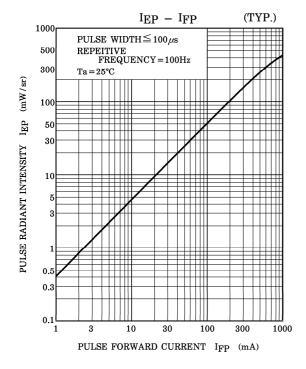


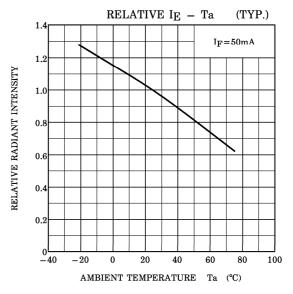


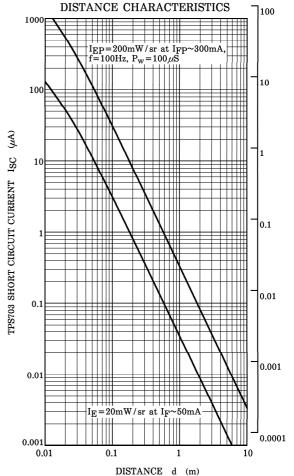
(mW/cm²)

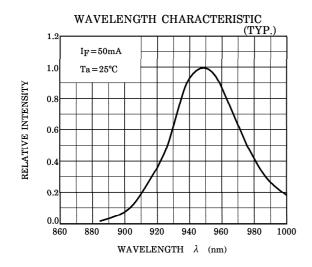
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CONVERTED RADIANT INCIDANCE









RADIATION PATTERN (Ta=25°C) (TYP.)

